

## High junction temperature Transil™

### Features

- ECOPACK®2 compliant product
- Peak pulse power:
  - 600 W (10/1000  $\mu$ s)
  - 4 kW (8/20  $\mu$ s)
- Stand off voltage: 5, 12 or 13 V
- Unidirectional type
- Low clamping voltage versus standard series
- Low leakage current, 0.2  $\mu$ A at 25 °C
- Operating  $T_j$  max: 175 °C
- JEDEC registered package outline

### Complies with the following standards

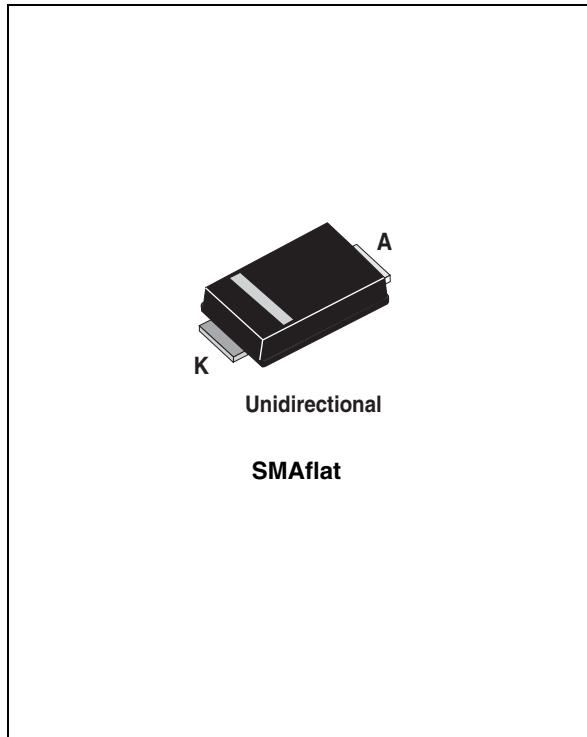
- IEC 61000-4-2 level 4:
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- MIL STD 883G-Method 3015-7: class3B
  - 25 kV (human body model)

### Description

The SMA6F Transil series has been designed to protect sensitive equipment against electro-static discharges according to IEC 61000-4-2, MIL STD 883 Method 3015, and electrical over stress such as IEC 61000-4-4 and 5. They are generally for surges below 600 W 10/1000  $\mu$ s.

This planar technology makes it compatible with high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time. Their low clamping voltages provides a better safety margin to protect sensitive circuits with extended life time expectancy.

Packaged in SMAflat non exposed pad, this minimizes PCB space consumption (footprint in accordance with IPC 7531 standard).



TM: Transil is a trademark of STMicroelectronics

# 1 Characteristics

**Table 1. Absolute ratings ( $T_{amb} = 25 \text{ }^{\circ}\text{C}$ )**

Symbol	Parameter		Value	Unit
$P_{PP}$	Peak pulse power dissipation <sup>(1)</sup>	$T_j$ initial = $T_{amb}$	600	W
$P$	Power dissipation on infinite heatsink	$T_{lead} = 55 \text{ }^{\circ}\text{C}$	6	W
$I_{FSM}$	Non repetitive surge peak forward current for unidirectional types	$t_p = 10 \text{ ms}$ $T_j$ initial = $T_{amb}$	60	A
$T_{stg}$	Storage temperature range		-65 to +175	$^{\circ}\text{C}$
$T_j$	Operating junction temperature range		-55 to +175	$^{\circ}\text{C}$
$T_L$	Maximum lead temperature for soldering during 10 s		260	$^{\circ}\text{C}$

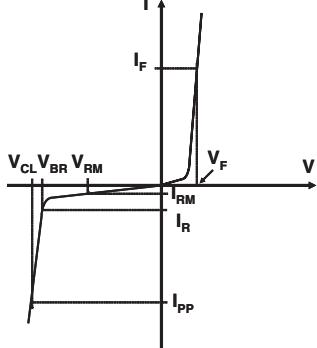
1. For a surge greater than the maximum values, the diode will fail in short-circuit.

**Table 2. Thermal resistance**

Symbol	Parameter	Value	Unit
$R_{th(j-l)}$	Junction to leads	20	$^{\circ}\text{C/W}$

**Table 3. Electrical characteristics - definitions ( $T_{amb} = 25 \text{ }^{\circ}\text{C}$ )**

Symbol	Parameter	
$V_{RM}$	Stand-off voltage	
$V_{BR}$	Breakdown voltage	
$V_{CL}$	Clamping voltage	
$I_{RM}$	Leakage current @ $V_{RM}$	
$I_{PP}$	Peak pulse current	
$\alpha T$	Voltage temperature coefficient	
$V_F$	Forward voltage drop	
$R_D$	Dynamic resistance	



**Table 4. Electrical characteristics - values ( $T_{amb} = 25^{\circ}\text{C}$ )**

Type	I <sub>RM</sub> max@V <sub>RM</sub>			V <sub>BR</sub> @ I <sub>R</sub> <sup>(1)</sup>			V <sub>CL</sub> @ I <sub>PP</sub> 10/1000 $\mu\text{s}$		R <sub>D</sub> <sup>(2)</sup> 10/1000 $\mu\text{s}$		V <sub>CL</sub> @ I <sub>PP</sub> 8/20 $\mu\text{s}$		R <sub>D</sub> <sup>(2)</sup> 8/20 $\mu\text{s}$		$\alpha T^{(3)}$
	25 °C	85 °C		min	typ	max	max		max		max		max		
	$\mu\text{A (Max)}$	V		V			mA	V	A	$\Omega$	V	A	$\Omega$	10-4/°C	
SMA6F5.0A	10	50	5.0	6.40	6.74	7.07	10	9.2	68	0.029	13.4	298	0.021	5.7	
SMA6F12AVCL	0.2	1	12	13.2	13.7	14.3	1	18.5	31	0.135	22.9	157	0.055	7.8	
SMA6F13A	0.2	1	13	14.4	15.2	15.9	1	20.4	29	0.154	23.9	147	0.054	8.3	

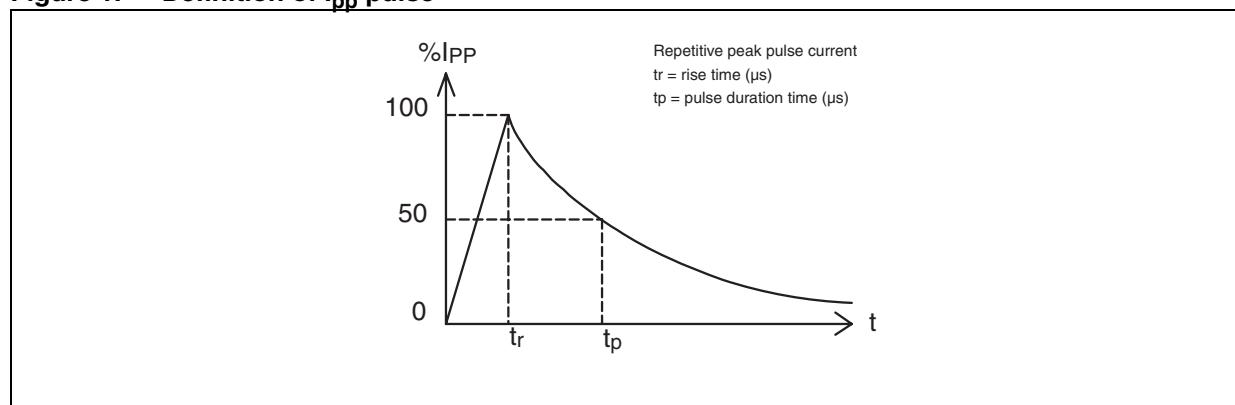
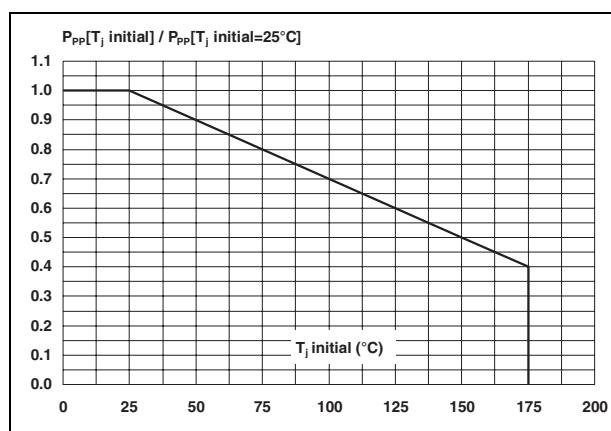
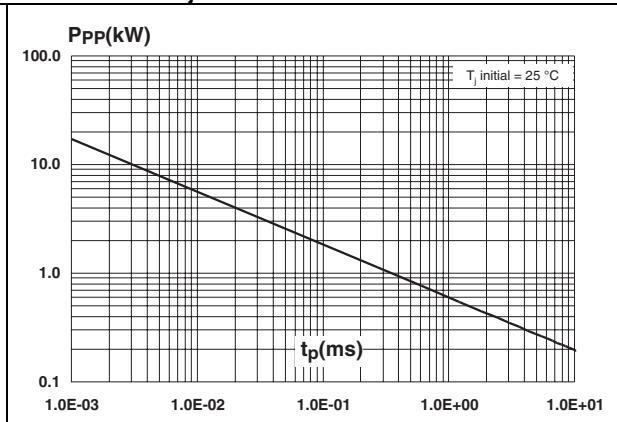
1. Pulse test:  $t_p < 50\text{ms}$ .

2. To calculate maximum clamping voltage at other surge currents, use the following formula

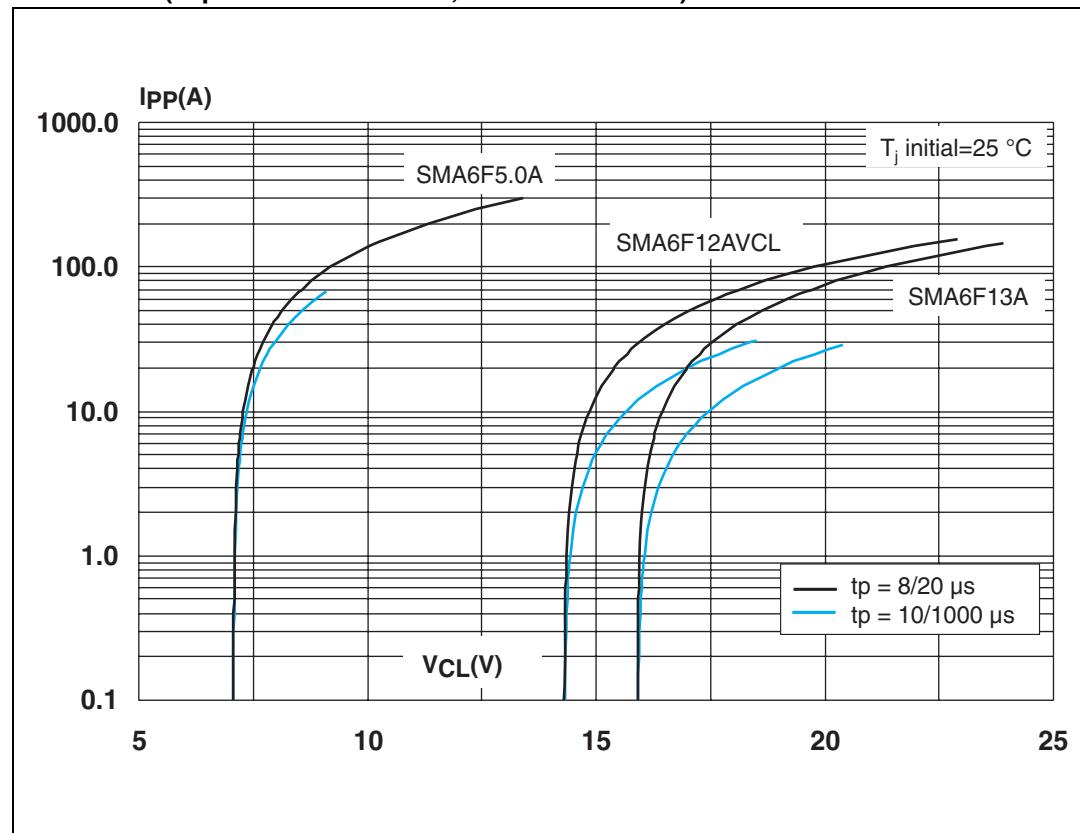
$$V_{CLmax} = R_D \times I_{PP} + V_{BRmax}$$

3. To calculate  $V_{BR}$  versus junction temperature, use the following formula:

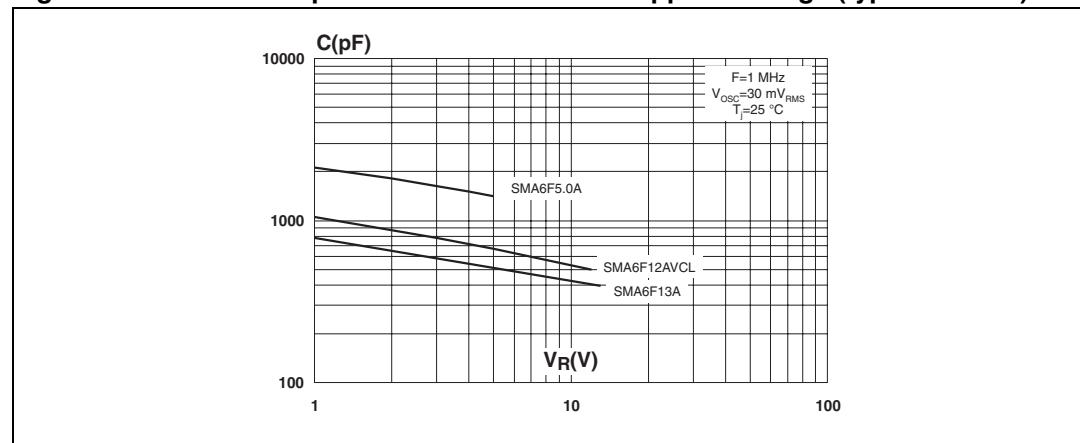
$$V_{BR} @ T_j = V_{BR} @ 25^{\circ}\text{C} \times (1 + \alpha T \times (T_j - 25))$$

**Figure 1. Definition of I<sub>pp</sub> pulse****Figure 2. Relative peak power dissipation versus initial junction temperature****Figure 3. Peak pulse power versus exponential pulse duration ( $T_j$  initial = 25 °C)**

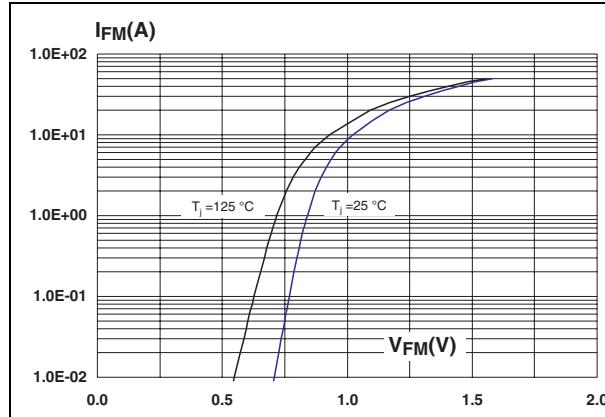
**Figure 4. Clamping voltage versus peak pulse current (exponential waveform, maximum values)**



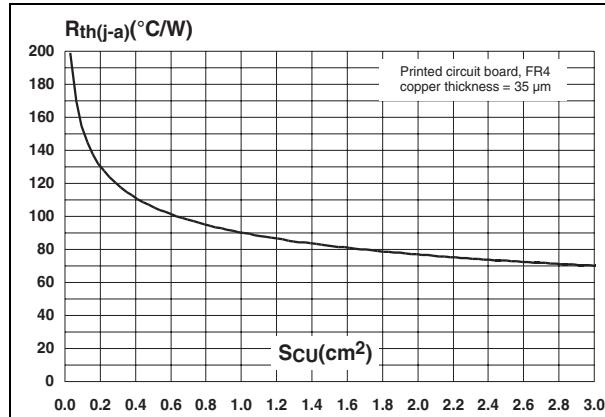
**Figure 5. Junction capacitance versus reverse applied voltage (typical values)**



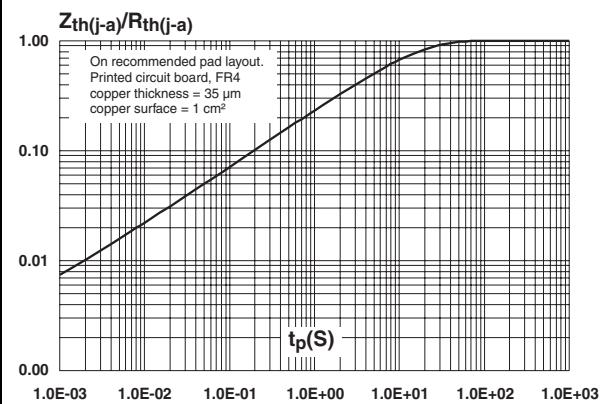
**Figure 6. Peak forward voltage drop versus peak forward current (typical values)**



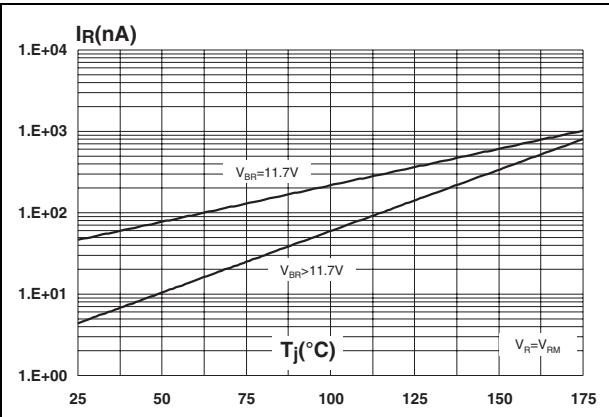
**Figure 8. Thermal resistance junction to ambient versus copper surface under each lead**



**Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration**

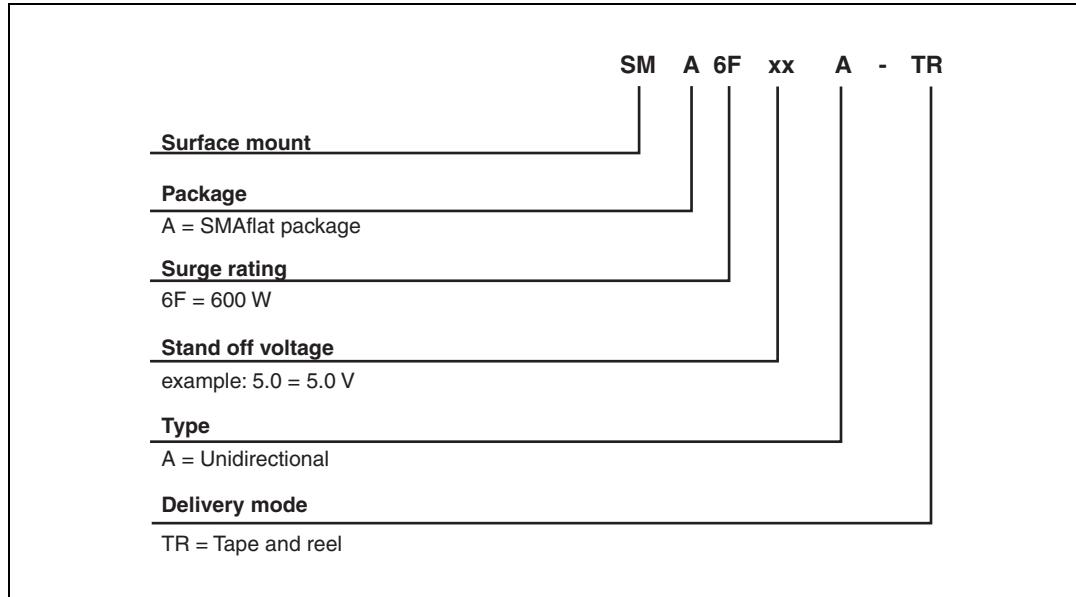


**Figure 9. Leakage current versus junction temperature (typical values)**



## 2 Ordering information scheme

**Figure 10. Ordering information scheme**



### 3 Package information

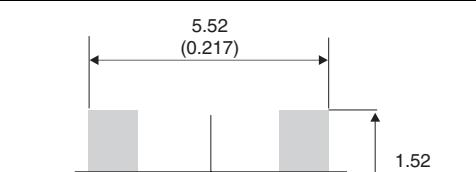
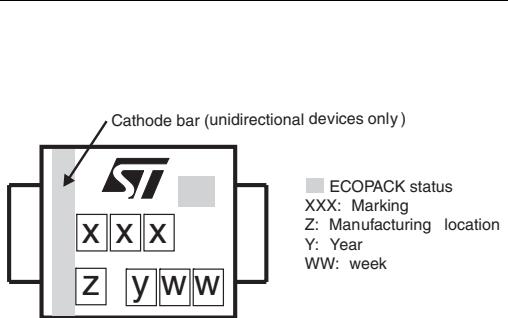
- Case: JEDEC DO-221AC molded plastic over Planar junction
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Band indicates cathode
- Flammability: Epoxy rated UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

**Table 5. SMAflat (non exposed pad) dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.043
b	1.25		1.65	0.049		0.065
c	0.15		0.40	0.006		0.016
D	2.25		2.95	0.088		0.116
E	4.80		5.60	0.189		0.220
E1	3.95		4.60	0.156		0.181
L	0.75		1.50	0.030		0.059
L1		0.50			0.019	
L2		0.50			0.019	

**Figure 11. SMAflat footprint dimensions** **Figure 12. Marking information**

 <p>5.52 (0.217)</p> <p>1.52 (0.060)</p> <p>1.20 (0.047)    3.12 (0.123)    1.20 (0.047)</p> <p>millimeters (inches)</p>	 <p>Cathode bar (unidirectional devices only)</p> <p>ECOPACK status</p> <p>XXX: Marking</p> <p>Z: Manufacturing location</p> <p>Y: Year</p> <p>WW: week</p>
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## 4 Ordering information

**Table 6. Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
SMA6F5.0A-TR	SUA	SMAflat	0.035 g	10000	Tape and reel
SMA6F12AVCL	SUJ				
SMA6F13A-TR	SUG				

For the latest information on available order codes see the product pages on [www.st.com](http://www.st.com).

## 5 Revision history

**Table 7. Document revision history**

Date	Revision	Changes
04-Sep-2008	1	First issue.
01-Sep-2011	2	Updated order code in <a href="#">Table 6</a> .

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